Overview

HP EliteBook 830 G6 Notebook PC



- 1. HD and IR Camera (Optional)
- 2. Ambient Light Sensor (Optional)
- 3. IR Camera LEDs (Optional)
- 4. Internal Microphones
- 5. Camera Shutter
- 6. HD Camera LED
- 7. Pointstick

Left

- 8. Glass Clickpad
- 9. Smartcard Reader (Optional)
- 10. USB 3.1 Gen 1 Charging Port
- 11. Vents
- 12. Standard Security Lock Slot (Lock sold separately)
- 13. Power Button



Overview



Right

- 1. Power Connector
- 2. USB Type-C[™] with Thunderbolt[™]
- 3. Docking Connector
- 4. Ethernet Port
- 5. HDMI Port (Cable not included)

- 6. USB 3.1 Gen 1 Port
- 7. Audio Combo Jack
- 8. SIM Card Slot¹
- 9. Touch Fingerprint Sensor (Optional)

1. All units have a SIM card stray but units that do not support WWAN are shipped with a non-removable SIM slot plug



Overview

At a Glance

- Eye-catching Ultraslim design, premium precision-crafted machined aluminum (CNC) chassis for clean, crisp, premium look and feel
- 8th Generation Intel[®] Core[™] i5, i7 Processors
- Preinstalled with Windows 10 versions or FreeDOS
- Designed to support all HP docking options including HP's traditional Ultraslim mechanical dock and all-new Thunderbolt dock²
- Featuring HP Collaboration Keyboard with Clickpad to manage most commonly used conferencing functions with a single keystroke
- Innovative world-facing third mic improves inbound ambient noise cancellation while 360 degree mic pick-up allows everyone to clearly hear and be heard
- Optional ultrabright displays with ambient light sensor
- Choice of displays:
 - 33.8 cm (13.3") diagonal FHD IPS Anti-Glare LED-backlit non-touch, 250 nits, 45% NTSC
 - 33.8 cm (13.3") diagonal FHD IPS Anti-Glare LED-backlit non-touch, 400 nits, 72% NTSC
 - 33.8 cm (13.3") diagonal FHD IPS Anti-Glare LED-backlit non-touch, 1000 nits, 72% NTSC with HP Sure View (Available 3Q 2019)
 - 33.8 cm (13.3") diagonal FHD IPS Anti-Glare On-Cell LED-backlit touch, 250 nits, 45% NTSC
 - 33.8 cm (13.3") diagonal FHD IPS Anti-Glare On-Cell LED-backlit touch, 1000 nits, 72% NTSC with HP Sure View (Available 3Q 2019)
- Enterprise grade security with HP Sure Sense⁵, HP SureStart Gen5, HP Privacy Camera, HP Sure View Gen3¹, HP Sure Run Gen2, HP Sure Recover Gen2 with Embedded Reimaging², HP Sure Click, SmartCard Reader² and Touch Fingerprint reader²
- Ultimate connectivity with optional CAT16 4G/LTE WWAN, and Thunderbolt™ Docking (dock sold separately)
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles³
- Flexible wireless connectivity options
- Choice of solid state drives up to 2 TB and DDR4 memory up to 32 GB
- Passed 19 MIL-STD 810G tests⁴
- UMA graphics: Up to 19 hours (Intel[®] 8th generation CPU and 3-cell 50 WHr battery)

1. HP Sure View Gen3 integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

2. Sold separately or as an optional feature

3. Recharges your battery up to 50% within 30 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 50% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.

4. MIL STD 810G testing is not intended to demonstrate fitness for U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

5. HP Sure Sense requires Windows 10. See product specifications for availability.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



PRODUCT NAME

HP EliteBook 830 G6 Notebook PC

OPERATING SYSTEMS

| Preinstalled | Windows 10 Pro 64 – HP recommends Windows 10 Pro ¹ Windows 10 Pro 64 (National Academic License) ² Windows 10 Home 64 ¹ Windows 10 Home Single Language 64 ¹ |
|--------------|---|
| | Windows 10 Pro (Windows 10 Enterprise available with a Volume Licensing Agreement) ¹ FreeDOS |

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com/.

2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

PROCESSORS

Intel[®] Core™ i7-8665U with Intel[®] UHD Graphics 620 (1.9 GHz base frequency, up to 4.8 GHz with Intel[®] Turbo Boost Technology, 8 MB L3 cache, 4 cores) ^{3,4,5,6}

Intel[®] Core™ i7-8565U with Intel[®] UHD Graphics 620 (1.8 GHz base frequency, up to 4.6 GHz with Intel[®] Turbo Boost Technology, 8 MB L3 cache, 4 cores)^{3,4,5,6}

Intel[®] Core[™] i5-8365U with Intel[®] UHD Graphics 620 (1.6 GHz base frequency, up to 4.1 GHz with Intel[®] Turbo Boost Technology, 6 MB L3 cache, 4 cores) ^{3,4,5,6}

Intel[®] Core[™] i5-8265U with Intel[®] UHD Graphics 620 (1.6 GHz base frequency, up to 3.9 GHz with Intel[®] Turbo Boost Technology, 6 MB L3 cache, 4 cores)^{3,4,5,6}

Intel[®] Core[™] i3-8145U with Intel[®] UHD Graphics 620 (2.1 GHz base frequency, up to 3.9 GHz with Intel[®] Turbo Boost Technology, 4 MB L3 cache, 2 cores)^{3,4,5,6}

Processor Family

8th Generation Intel[®] Core™ i7 processor (i7-8665U and i7-8565U)⁶

- 8th Generation Intel[®] Core™ i5 processor (i5-8365U and i5-8265U)⁶
- 8th Generation Intel[®] Core[™] i3 processor (i3-8145U)⁶

3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
 Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.

6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.



CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated Intel[®] UHD Graphics 620⁷

Supports Support HD decode, DX12, HDMI 1.4b⁸

7. HD content required to view HD images.

8. HDMI cable sold separately.

DISPLAY

Non-Touch

33.8 cm (13.3") diagonal FHD IPS eDP anti-glare WLED-backlit slim, 250 nits, 45% NTSC (1920 x 1080)^{7,9,10}
33.8 cm (13.3") diagonal FHD IPS eDP anti-glare WLED-backlit slim for HD camera, 250 nits, 45% NTSC (1920 x 1080)^{7,9,10}
33.8 cm (13.3") diagonal FHD IPS eDP anti-glare WLED-backlit slim for HD+IR camera, 250 nits, 45% NTSC (1920 x 1080)^{7,9,10}
33.8 cm (13.3") diagonal FHD IPS eDP anti-glare WLED-backlit slim for HD+IR camera, 250 nits, 45% NTSC (1920 x 1080)^{7,9,10}
33.8 cm (13.3") diagonal FHD IPS eDP anti-glare WLED-backlit slim for WWAN, 250 nits, 45% NTSC (1920 x 1080)^{7,9,10}
33.8 cm (13.3") diagonal FHD IPS eDP anti-glare WLED-backlit slim for HD camera and WWAN, 250 nits, 45% NTSC (1920 x 1080)^{7,9,10}
33.8 cm (13.3") diagonal FHD IPS eDP anti-glare WLED-backlit slim for HD camera and WWAN, 250 nits, 45% NTSC (1920 x 1080)^{7,9,10}

33.8 cm (13.3") diagonal FHD IPS eDP anti-glare LED-backlit slim for HD+IR camera and WWAN, 250 nits, 45% NTSC (1920 x 1080) ^{7,9,10}

33.8 cm (13.3") diagonal FHD IPS eDP + PSR anti-glare WLED-backlit ultraslim with Ambient Light Sensor for HD+IR camera, 400 nits, 72% NTSC (1920 x 1080)^{7,9,10}

33.8 cm (13.3") diagonal FHD IPS eDP + PSR anti-glare WLED-backlit ultraslim with Ambient Light Sensor for HD+IR camera and WWAN, 400 nits, 72% NTSC (1920 x 1080)^{7,9,10}

33.8 cm (13.3") diagonal FHD IPS eDP + PSR WLED-backlit ultraslim with HP Sure View Gen3 Integrated Privacy Screen, Ambient Light Sensor for HD+IR camera and WWAN, 1000 nits, 72% NTSC (1920 x 1080)^{7,9,10,11} (Available 3Q 2019)

Touch

33.8 cm (13.3") diagonal FHD IPS eDP anti-glare on-cell WLED-backlit slim touch screen for HD+IR camera, 250 nits, 45% NTSC (1920 x 1080)^{7,9,10}

33.8 cm (13.3") diagonal FHD IPS eDP anti-glare on-cell WLED-backlit slim touch screen for HD+IR camera and WWAN, 250 nits, 45% NTSC (1920 x 1080)^{7,9,10}

33.8 cm (13.3") diagonal FHD IPS eDP + PSR anti-glare on-cell WLED-backlit ultraslim touch screen with HP Sure View Gen3 Integrated Privacy Screen, Ambient Light Sensor for HD+IR camera and WWAN, 1000 nits, 72% NTSC (1920 x 1080)^{7,9,10,11} (Available 3Q 2019)

HDMI 1.4b

Supports resolution up to 4k @ 60Hz via DP and @ 30Hz via HDMI

Displays support

Supports 3 independent displays if used with optional HP UltraSlim Docking Station.2

7. HD content required to view HD images.

9. Sold separately or as an optional feature.

10. Resolutions are dependent upon monitor capability, and resolution and color depth settings.



11. HP Sure View Gen3 integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

| Docking station model | Total number of supported displays (incl. the notebook) display) | Max. resolutions supported | Dock Connectors | Technical limitations |
|---|--|--|--|--|
| HP UltraSlim Docking Station (Quest) | 3 | Dual 2.5K @ 60Hz | 2xDP, 1xVGA | Dual 2.5k only with both displays intoDP |
| HP Thunderbolt Dock G2 | 3 | Dual 4K @ 60Hz | 2xDP, 1xVGA, 1xTB, 1xUSB-C alt-mode | Dual 4k (4096 x 2160) only with: • 1 DP + TB port or • USB-C alt mode + TB port Dual 4K (3840 x 2160) with any of the DP, TB or USB-C alt mode video ports |
| HP Elite USB-C Dock G4 | 3 | Dual 2K @ 60Hz Single 4K @ 60Hz (3840 x 1440) | 1xHDMI, 2xDP | |
| HP USB-C Universal Dock | 3 | Dual 4K @ 60Hz Single 5K @ 60Hz | 2xDP | |
| HP USB-C Travel Dock | 2 | Single 2K @ 60Hz | 1xHDMI, 1xVGA | Single external display Only HDMI or VGA at the time |

STORAGE AND DRIVES

Primary Storage

128 GB SATA-3 SS TLC¹² 256 GB PCIe NVMe Value SS TLC¹² 256 GB PCIe Gen3x4 NVMe SS TLC¹² 256 GB SATA-3 SS TLC Opal 2¹² 512 GB PCIe NVMe Value¹² 512 GB PCIe Gen3x4 NVMe SS TLC¹² 512 GB Intel® PCIe® NVMe[™] QLC + 32 GB Intel® Optane[™] (Memory Planned to be available Q3 2019)¹² 512 GB PCIe Gen3x4 NVMe SS TLC Opal 2¹² 512 GB SATA-3 SS TLC FIPS-140-2¹² 1 TB PCIe Gen3x4 NVMe SS TLC¹² 2 TB PCIe Gen3x4 NVMe SS TLC¹²

12. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.



MEMORY

Maximum Memory

32 GB DDR4-2400 SDRAM¹³

Memory

32 GB DDR4-2400 SDRAM (2 X 16 GB)¹³ 16 GB DDR4-2400 SDRAM (1 X 16 GB)¹³ 16 GB DDR4-2400 SDRAM (2 X 8 GB)¹³ 8 GB DDR4-2400 SDRAM (1 x 8 GB)¹³ 8 GB DDR4-2400 SDRAM (2 x 4 GB)¹³ 4 GB DDR4-2400 SDRAM (1 x 4 GB)¹³

Memory Slots

2 SODIMM Both slots are customer accessible / upgradeable DDR4 SODIMMS, system runs at 2400 Supports Dual Channel Memory

13. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.



NETWORKING/COMMUNICATIONS

WLAN

Intel[®] Dual Band Wireless-AC 9560 802.11a/b/g/n/ac (2x2) Wi-Fi[®] and Bluetooth[®] 5 Combo, vPro^{™14} Intel[®] Dual Band Wireless-AC 9560 802.11a/b/g/n/ac (2x2) Wi-Fi[®] and Bluetooth[®] 5 Combo, non-vPro^{™14} Intel[®] Wi-Fi 6 AX200 802.11a/b/g/n/ac/ax (2x2) and Bluetooth[®] 5 Combo, vPro^{™15} Intel[®] Wi-Fi 6 AX200 802.11a/b/g/n/ac/ax (2x2) Bluetooth[®] 5 Combo, non-vPro^{™15}

WWAN

Intel[®] XMM[™] 7360 LTE-Advanced Cat 9¹⁶ Intel[®] XMM[™] 7560 LTE-Advanced Pro Cat 16¹⁷ Intel[®] XMM[™] 7262 LTE-Advanced Cat 6¹⁶

NFC

NPC300 Near Field Communication module

Miracast

Native Miracast Support¹⁸

Ethernet

Intel[®] I219-LM 10/100/1000 GbE, vPro^{™19} Intel[®] I219-V 10/100/1000 GbE, non-vPro^{™19}

14. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.

15. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices.

16. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

17. Gigabit class Category 16 4G LTE module is optional and must be configured at the factory. Module designed for up to 1 Gbps download speeds as carriers deploy 5 carrier aggregation and 100Mhz channel bandwidth, requires activation and separately purchased service contract. Backwards compatible to HSPA 3G technologies. Check with service provider for coverage and availability in your area. Connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

18. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming. 19. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.



AUDIO/MULTIMEDIA

Audio

Audio by Bang & Olufsen 2 Integrated stereo speakers Integrated 3 Multi Array Microphone

Camera

720p HD camera^{7,9} 720p HD IR camera^{7,9}

Sensors

Ambient light sensor (Select models only)

7. HD content required to view HD images.

9. Sold separately or as an optional feature.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Collaboration Keyboard, backlit and spill resistant with drain Backlit keyboard available as an option

Pointing Device

Clickpad with multi-touch gestures enabled, taps enabled as default Microsoft Precision Touchpad Default Gestures Support

Function Keys

F1 - Display Switching F2 - Blank or Privacy F3 - Brightness Down F4 - Brightness Up F5 - Audio Mute F6 - Volume Down F7 - Volume Up F8 - Mic Mute F9 - Blank or Backlit Toggle F10 - numlk F11 - Wireless F12 - Calendar Share/Present Call Answer Call End

Hidden Function Keys

Fn+R - Break Fn+S - Sys Rq Fn+C - Scroll Lock Fn+E - Insert Fn+W - Pause



SOFTWARE AND SECURITY

Preinstalled Software

BIOS

HP BIOSphere Gen5²⁰ HP Drive Lock & Automatic Drive Lock²¹ BIOS Update via Network Master Boot Record Security Power On Authentication Secure Erase²² Absolute Persistence Module²³ Pre-boot Authentication

Software

HP Native Miracast Support²⁴ HP Connection Optimizer HP Image Assistant HP Hotkey Support HP JumpStart HP Support Assistant²⁵ HP Noise Cancellation Software Buy Office (sold separately)

Manageability Features

HP Driver Packs²⁶ HP System Software Manager (SSM) HP BIOS Config Utility (BCU) HP Client Catalog HP Manageability Integration Kit Gen3²⁷ Ivanti Management Suite

Client Security Software

HP Client Security Manager Gen5²⁸ HP Fingerprint Sensor²⁹ HP Power On Authentication Windows Defender³⁰

Security Management

Pre-boot Authentication TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified) SATA 0,1 port disablement (via BIOS) Serial, USB enable/disable (via BIOS) Power-on password (via BIOS) Setup password (via BIOS) Support for chassis padlocks and cable lock devices HP Sure Click³¹ HP Sure Start Gen5³² HP Sure Run Gen2³³ HP Sure Recover Gen2³⁴ HP Sure Sense³⁵

TPM

Model: Infineon SLB9670 Version: 7.85



Revision: TPM 2.0 FIPS 140-2 Compliant: Yes

Smartcard Reader Model number: Alcor AU9560 FIPS 201 Compliant: Yes

IPv6 Certification:

Yes

MD5 Hash: Please follow the instructions below to access MD5 Hash.

Log-on to http://hp.com/support, enter your product name, select software and drivers, select OS, select driver. After selecting the driver, click on "Associated files" and then click on "Download". When opening the file, under "Purpose" you should see the appropriate "SOFTPAQ MD5:" Field

Graphics (Intel Video Driver): TBD WWAN: TBD WLAN: TBD

Is the BIOS on this notebook ISO/IEC 19678:2015 (formerly NIST 800-147) compliant?:

Yes UEFI version: 2.6

20. HP BIOSphere Gen5 is available on select HP Pro and Elite PCs. See product specifications for details. Features may vary depending on the platform and configurations.

21. HP Automatic Drive Lock is not supported on NVMe drives.

22. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

23. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:

http://www.absolute.com/company/legal/agreements/ computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

24. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

25. HP Support Assistant requires Windows and Internet access.

26. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.

27. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.

28. HP Client Security Manager Gen5 requires Windows and is available on the select HP Pro and Elite PCs. See product specifications for details.

29. HP Fingerprint Sensor sold separately or as an optional feature.

30. Windows Defender Opt in and internet connection required for updates.

31. HP Sure Click is available on select HP platforms and supports Microsoft Internet Explorer, Google Chrome[™], and Chromium[™]. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode, when Microsoft Office or Adobe Acrobat are installed.

32. HP Sure Start Gen5 is available on select HP PCs with Intel processors. See product specifications for availability.

33. HP Sure Run Gen2: See product specifications for availability.



34. HP Sure Recover Gen2: See product specifications for availability. Requires an open, wired network connection. Not available on platforms with multiple internal storage drives. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. HP Sure Recover (Gen1) does not support platforms with Intel[®] Optane[™]. 35. HP Sure Sense requires Windows 10. See product specifications for availability.

POWER

Power Supply

HP Smart 45 W External AC power adapter³⁶ HP Smart 45 W External AC power adapter, 2-prong (Japan only)³⁶ HP Smart 65 W External AC power adapter³⁶ HP Smart 65 W EM External AC power adapter³⁶ 45 W USB Type-C[™] adapter³⁶ 65 W USB Type-C[™] adapter³⁶

Primary Battery

HP Long Life 3-cell, 50 Wh Li-ion³⁷

Battery Life

UMA graphics: Up to 19 hours (Intel® 8th generation CPU and 3-cell 50 WHr battery)³⁸

Power Cord

2-wire plug - 1m³⁶ 3-wire plug - 1m³⁶ 3-wire plug - 1.8m³⁶ Duckhead power cord - 1.0m³⁶ Duckhead power cord - 1.8m³⁶

Battery Weight

193 +/- 10g

36. Availability may vary by country.

37. Battery is internal and not replaceable by customer. Serviceable by warranty.

38. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See http://www.bapco.com for additional details



WEIGHTS & DIMENSIONS

Product Weight

Starting at 2.94 lb (non-touch); Starting at 3.18 lb (touch)³⁹ Starting at 1.33 kg (non-touch); Starting at 1.44 kg (touch)³⁹

Product Dimensions (W x D x H)

Non-Touch 12.22 x 9.03 x 0.7 in 31.04 x 22.93 x 1.77 cm

Touch 12.22 x 9.03 x 0.7 in 31.04 x 22.93 x 1.78 cm

39. Weight will vary by configuration.

PORTS/SLOTS

Thunderbolt[™] (USB Type-C[™] connector)
 USB 3.1 Gen 1 (1 charging)
 docking connector
 HDMI 1.4⁸
 RJ-45
 AC power
 Headphone/microphone combo jack
 SIM card slot⁴⁰
 Smartcard reader (Optional)
 Standard Security Lock Slot (Lock sold separately)

8. HDMI cable sold separately. 40. All units have a SIM card slot and icon but units that do not support WWAN are shipped with a non-removable SIM slot plug

SERVICE AND SUPPORT

HP Services offers 1-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. Onsite service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.⁴¹

41. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



Technical Specifications

SYSTEM UNIT

| Stand-Alone Power Requirements (AC Power) | Nominal Operating Voltage | 19 V |
|--|------------------------------------|--|
| | Average Operating Power | Win10 |
| | Integrated Graphics | 6.78W |
| | Max Operating Power | UMA < 45W |
| Temperature | Operating | 32° to 95° F (0° to 35° C) |
| | Non-operating | -4° to 140° F (-20° to 60° C) |
| Relative Humidity | Operating | 10% to 90%, non-condensing |
| | Non-operating | 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature |
| Shock | Operating | 40 G, 2 ms, half-sine |
| | Non-operating | 200 G, 2 ms, half-sine |
| Random Vibration | Operating | 0.75 grms |
| | Non-operating | 1.50 grms |
| Altitude (unpressurized) | Operating | -50 to 10,000 ft (-15.24 to 3,048 m) |
| | Non-operating | -50 to 40,000 ft (-15.24 to 12,192 m) |
| Planned Industry Standard | UL | Yes |
| Certifications | CSA | Yes |
| | FCC Compliance | Yes |
| | ENERGY STAR [®] qualified | Select models ⁴² |
| | EPEAT® | Registered Silver in United States ⁴³ |
| | ICES | Yes |
| | Australia | Yes |
| | NZ A-Tick Compliance | Yes |
| | CCC | Yes |
| | Japan VCCI Compliance | Yes |
| | KC | Yes |
| | BSMI | Yes |
| | CE Marking Compliance | Yes |
| | BNCI or BELUS | Yes |
| | CIT | Yes |
| | GOST | Yes |
| | Saudi Arabian Compliance (ICCP) | Yes |
| | SABS | Yes |

42. Configurations of the HP Elitebook 830 G6 that are ENERGY STAR[®] certified are identified as HP Elitebook 830 G6 ENERGY STAR on HP websites and on http://www.energystar.gov.

43. EPEAT[®] registered where applicable. EPEAT registration varies by country. See http://www.epeat.net for registration status by country. Search keyword generator on HP's 3rd party option store for solar generator accessories at http://www.hp.com/go/options.



DISPLAYS

| Panel LCD 13.3 inch diagonal FHD (1920 x 1080) Anti-Glare WLED UWVA 45 percent cg 250 nits eDP 1.2 | Outline Dimensions (W x H x D) | 300.56 x 187.77 mm (max) (w/ PCB & w/o bracket) |
|---|--|--|
| | Active Area | 293.76 x 165.24 mm (typ.) |
| | Weight | 260 g (max) |
| w/o PSR slim | Diagonal Size | 13.3 inch |
| | Thickness | 3.0 mm (max) |
| | Interface | eDP 1.2 (2 lane) |
| | Surface Treatment | Anti-Glare |
| | Touch Enabled | No |
| | Contrast Ratio | 600:1 (typ.) |
| | Refresh Rate | 60 Hz |
| | Brightness | 250 nits (typ.) |
| | Pixel Resolution | 1920 x 1080 (FHD) |
| | Format | NTSC |
| | Backlight | LED |
| | Color Gamut Coverage | 45% |
| | Color Depth | 6 bits |
| | Viewing Angle | UWVA 85/85/85 |
| | | |
| Panel LCD 13.3 inch diagonal FHD (1920 x 1080) Anti-Glare WLED UWVA 45 percent cg 250 nits eDP slim On-cell Touch | Outline Dimensions (W x H x D) Active Area Weight Diagonal Size Thickness Interface Surface Treatment Touch Enabled Contrast Ratio Refresh Rate Brightness Pixel Resolution Format Backlight Color Gamut Coverage Color Depth | 300.56 x 187.77 293.76 x 165.24 mm (typ.) 268 g (max) 13.3 inch 3.2 mm (max) eDP 1.2 Anti-Glare On-cell Yes 600:1 (typ.) 60 Hz 250 nits 1920 x 1080 (FHD) NTSC LED 45% 6 bits |
| diagonal FHD (1920 x 1080) Anti-Glare WLED UWVA 45 percent cg 250 nits eDP | Active Area Weight Diagonal Size Thickness Interface Surface Treatment Touch Enabled Contrast Ratio Refresh Rate Brightness Pixel Resolution Format Backlight Color Gamut Coverage | 293.76 x 165.24 mm (typ.) 268 g (max) 13.3 inch 3.2 mm (max) eDP 1.2 Anti-Glare On-cell Yes 600:1 (typ.) 60 Hz 250 nits 1920 x 1080 (FHD) NTSC LED 45% |



| Panel LCD 13.3 inch | Outline Dimensions (W x H x D) | |
|---|--------------------------------|-----------------------------|
| diagonal FHD (1920 x 1080) Anti-Glare WLED UWVA 72 | | 299.06 x 185.54 mm (max) |
| | Active Area | 293.76 x 165.24 mm (typ.) |
| percent cg 400 nits eDP | Weight Discourse Cinc | 170 g (max) |
| 1.4+PSR2 Slim | Diagonal Size | 13.3 inch |
| | Thickness | 2.0 mm (max) |
| | Interface | eDP 1.4 + PSR2 (2 lane) |
| | Surface Treatment | Anti-Glare |
| | Touch Enabled | No |
| | Contrast Ratio | 1200:1 (typ.) |
| | Refresh Rate | 60 Hz |
| | Brightness | 400 nits |
| | Pixel Resolution | 1920 x 1080 (FHD) |
| | Format | NTSC |
| | Backlight | LED |
| | Color Gamut Coverage | 72% |
| | Color Depth | 8 bits |
| | Viewing Angle | UWVA 85/85/85 |
| Paul LCD 42 2 inch | | 215 21 105 400 mm (mm) |
| Panel LCD 13.3 inch diagonal FHD (1920 x 1080) | Outline Dimensions (W x H x D) | 315.31 x 195.498 mm (max) |
| Anti-Glare WLED UWVA 72 | Active Area | 309.312 x 173.988 mm (typ.) |
| percent cg 1000 nits eDP | Weight | 265 g (max) |
| 1.4+PSR2 flat Privacy | Diagonal Size | 13.3 inch |
| | Thickness | 3.0 mm (max) |
| | Interface | eDP 1.4 + PSR2 (4 lane) |
| | Surface Treatment | Anti-Glare |
| | Touch Enabled | No |
| | Contrast Ratio | 2000:1 (typ.) |
| | Refresh Rate | 60 Hz |
| | Brightness | 1000 nits |
| | Pixel Resolution | 1920 x 1080 (FHD) |
| | Format | RGB |
| | Backlight | LED |
| | Color Gamut Coverage | 72% |
| | Color Depth | 8 bits |
| | Viewing Angle | UWVA 85/85/85/85 |
| | | |



Technical Specifications

| Panel LCD 13.3 inch | Outline Dimensions (W x H x D) | 299.06 x 186.54 mm (max) |
|---|--------------------------------|---------------------------|
| diagonal FHD (1920 x 1080) | Active Area | 293.76 x 165.24 mm (typ.) |
| Anti-Glare WLED UWVA 72 percent cg 1000 nits | Weight | 260 g (max) |
| eDP+PSR flat On-cell Touch | Diagonal Size | 13.3 inch |
| Privacy | Thickness | 3.2 mm (max) |
| | Interface | eDP 1.4 + PSR2 (4 lane) |
| | Surface Treatment | Anti-Glare On-cell |
| | Touch Enabled | YES |
| | Contrast Ratio | 2000:1 (typ.) |
| | Refresh Rate | 60 Hz |
| | Brightness | 1000 nits |
| | Pixel Resolution | 1920 x 1080 (FHD) |
| | Format | RGB |
| | Backlight | LED |
| | Color Gamut Coverage | 72% |
| | Color Depth | 8 bits |
| | Viewing Angle | UWVA 85/85/85/85 |

STORAGE AND DRIVES

| SSD 128 GB 2280 M2 SATA- | Form Factor | M.2 2280 |
|--------------------------|--------------------------|--|
| 3 TLC | Capacity | 128 GB |
| | NAND Type | TLC |
| | Height | 0.09 in (2.3 mm) |
| | Width | 0.87 in (22 mm) |
| | Weight | 0.02 lb (10 g) |
| | Interface | ATA-8, SATA 3.0 |
| | Maximum Sequential Read | Around 540 ~ 560 MB/s |
| | Maximum Sequential Write | Around 380 ~ 530 MB/s |
| | Logical Blocks | 250,069,680 |
| | Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] |
| | Features | ATA Security; DIPM; TRIM; DEVSLP |
| SSD 1 TB 2280 PCIe-3x4 | Form Factor | M.2 2280 |
| NVMe Three Layer Cell | | 1 TB |
| single-sided | Capacity | |
| | NAND Type | |
| | Height | 0.09 in (2.3 mm) |
| | Width | 0.87 in (22 mm) |
| | Weight | 0.02 lb (10 g) |
| | Interface | PCIe NVMe Gen3X4 |
| | | |



Technical Specifications

| - | Maximum Sequential Read | Around 3200 ~ 3480 MB/s | |
|--|--|--|--|
| | Maximum Sequential Write | Around 2400 ~ 3037 MB/s | |
| | Logical Blocks | 2,000,409,264 | |
| | Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] | |
| | Features | ATA Security; TRIM; L1.2 | |
| | | | |
| SSD 256 GB 2280 M2 PCIe- | Form Factor | M.2 2280 | |
| 3x4 SS NVMe TLC | Capacity | 256 GB | |
| | NAND Type | TLC | |
| | Height | 0.09 in (2.3 mm) | |
| | Width | 0.87 in (22 mm) | |
| | Weight | 0.02 lb (10 g) | |
| | Interface | PCIe NVMe Gen3X4 | |
| | Maximum Sequential Read | Around 2900 ~ 3167 MB/s | |
| | Maximum Sequential Write | Around 1300 ~ 1663 MB/s | |
| | Logical Blocks | 500,118,192 | |
| | Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] | |
| | Features | ATA Security; TRIM; L1.2 | |
| SSD 256 GB 2280 M2 SATA- 3 Self Encrypted OPAL2 Three Layer Cell | Form Factor Capacity NAND Type Height Width Weight Interface Maximum Sequential Read Maximum Sequential Write Logical Blocks Operating Temperature Features | M.2 2280 256 GB TLC 0.09 in (2.3 mm) 0.87 in (22 mm) 0.02 lb (10 g) ATA-8, SATA 3.0 Around 530 ~ 560 MB/s Around 500 ~ 530 MB/s 500,118,192 32° to 158°F (0° to 70°C) [ambient temp] ATA Security; TCG OPAL 2.0; DIPM; TRIM; DEVSLP | |
| 5SD 256 GB 2280 PCIe NVMe Value | Form Factor Capacity NAND Type | M.2 2280 256 GB TLC | |
| | Height Width Weight Interface Maximum Sequential Read | 0.09 in (2.3 mm) 0.87 in (22 mm) 0.02 lb (10 g) PCle NVMe Gen3X4 Around 1500 ~ 1700 MB/s | |

Not all configuration components are available in all regions/countries. c06308181 — DA 16443 - Worldwide — Version 3 — May 30, 2019

Technical Specifications

| | Maximum Sequential Write Logical Blocks Operating Temperature | Around 780 ~ 1300 MB/s 500,118,192 32° to 158°F (0° to 70°C) [ambient temp] | |
|---|---|---|------|
| | Features | ATA Security; TRIM; L1.2 | |
| 2 TB 2280 PCIe-3x4 NVMe | Form Factor | M.2 2280 | |
| Three Layer Cell single- | Capacity | 2 TB | |
| sided | NAND Type | TLC | |
| | Height | 0.09 in (2.3 mm) | |
| | Width | 0.87 in (22 mm) | |
| | Weight | 0.02 lb (10 g) | |
| | Interface | PCIe NVMe Gen3X4 | |
| | Maximum Sequential Read | Around 2900 ~ 3000 MB/s | |
| | Maximum Sequential Write | Around 2100 MB/s | |
| | Logical Blocks | 3,907,029,168 | |
| | Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] | |
| | Features | ATA Security; TRIM; L1.2 | |
| | P | N 2 2200 | |
| SSD 512 GB 2280 M2 PCIe- 3x4 SS NVMe TLC | Form Factor | M.2 2280 | |
| JAH JJ NVME I EC | Capacity | 512 GB | |
| | NAND Type | TLC | |
| | Height | 0.09 in (2.3 mm) | |
| | Width | 0.87 in (22 mm) | |
| | Weight | 0.02 lb (10 g) | |
| | Interface | PCIe NVMe Gen3X4 | |
| | Maximum Sequential Read | Around 2700 ~ 3400 MB/s | |
| | Maximum Sequential Write | Around 1390 ~ 2956 MB/s | |
| | Logical Blocks | 1,000,215,215 | |
| | Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] | |
| | Features | ATA Security; TRIM; L1.2 | |
| SSD 512 GB 2280 M2 SATA- | Form Factor | M.2 2280 | |
| 3 Three Layer Cell Federal | Capacity | 512 GB | |
| Information Processing Standard | NAND Type | TLC | |
| Standard | Height | 2.6 mm Max | |
| | Width | 0.87 in (22 mm) | |
| | Weight | 0.02 lb (10 g) | |
| | Interface | ACS-3, SATA 3.2 | |
| | Maximum Sequential Read | Around 530 MB/s | |
| | Maximum Sequential Write | Around 400 MB/s | |
| hp | | ents are available in all regions/countries. Vorldwide — Version 3 —May 30, 2019 | Page |

| | Logical Blocks | 1,000,215,216 |
|------------------------------------|--------------------------|--|
| | Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] |
| | Features | ATA Security; TCG Opal 2.0; FIPS; DIPM; TRIM; DEVSLP |
| | | |
| SSD 512 GB 2280 PCIe NVMe Value | | M.2 2280 |
| Value | Capacity | 512 GB |
| | NAND Type | TLC/QLC |
| | Height | 0.09 in (2.3 mm) |
| | Width | 0.87 in (22 mm) |
| | Weight | 0.02 lb (10 g) |
| | Interface | PCIe NVMe Gen3X4 |
| | Maximum Sequential Read | Around 1500 ~ 1700 MB/s |
| | Maximum Sequential Write | Around 860 ~ 1500 MB/s |
| | Logical Blocks | 1,000,215,215 |
| | Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] |
| | Features | ATA Security; TRIM; L1.2 |
| SD 512 GB 2280 PCIe-3x4 | Form Factor | M.2 2280 |
| NVMe Self Encrypted OPAL2 | Capacity | 512 GB |
| Three Layer Cell | NAND Type | TLC |
| | Height | 0.09 in (2.3 mm) |
| | Width | 0.87 in (22 mm) |
| | Weight | 0.02 lb (10 g) |
| | Interface | PCIe NVMe Gen3X4 |
| | Maximum Sequential Read | Around 2900 ~ 3400 MB/s |
| | Maximum Sequential Write | Around 1000 ~ 2500 MB/s |
| | Logical Blocks | 1,000,215,216 |
| | Operating Temperature | 32° to 158°F (0° to 70°C) [ambient temp] |
| | Features | ATA Security; TCG Opal 2.0; FIPS; DIPM; TRIM; DEVSLP |



Technical Specifications

NETWORKING/COMMUNICATIONS

| Intel® 9560 802.11a/b/g/n/ac (2x2) Wi-Fi® and Bluetooth® 5.0 Combo ¹ vPro | Wireless LAN Standards Interoperability Frequency Band | IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac Wi-Fi® certified 802.11b/g/n •2.402 - 2.482 GHz 802.11a/n •4.9 - 4.95 GHz (Japan) •5.15 - 5.25 GHz •5.25 - 5.35 GHz •5.47 - 5.725 GHz •5.825 - 5.850 GHz |
|---|--|--|
| | Data Rates | •802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) •802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz & 160MHz) |
| | Modulation | Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM |
| | Security ³ | IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.11i Cisco Certified Extensions, all versions through CCX4 and CCX Lite WAPI |
| | Network Architecture Models | Ad-hoc (Peer to Peer) Infrastructure (Access Point Required) |
| | Roaming Output Power ² | IEEE 802.11 compliant roaming between access points •802.11b: +18.5dBm minimum •802.11g: +17.5dBm minimum •802.11a: +18.5dBm minimum •802.11n HT20(2.4GHz): +15.5dBm minimum •802.11n HT40(2.4GHz): +14.5dBm minimum •802.11n HT20(5GHz): +15.5dBm minimum •802.11n HT40(5GHz): +14.5dBm minimum •802.11ac VHT80(5GHz): +11.5dBm minimum •802.11ac VHT160(5GHz): +11.5dBm minimum |
| | Power Consumption | •Transmit mode 2.0 W •Receive mode 1.6 W •Idle mode (PSP) 180 mW (WLAN Associated) •Idle mode 50 mW (WLAN unassociated) •Connected Standby 10mW •Radio disabled 8 mW |



| Power Management | ACPI and PCI Express compliant power management 802.11 compliant power saving mode | | |
|-----------------------------------|--|---|--|
| Receiver Sensitivity ³ | 802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum | | |
| Antenna type | High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications | | |
| Form Factor | PCI-Express M.2 MiniCard | | |
| Dimensions | Type 2230: 2.3 x 22.0 x 30.0 mm | | |
| Weight | Туре 2230: 2.8g | | |
| Operating Voltage | 3.3v +/- 9% | | |
| Temperature | Operating Non-operating | 14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C) | |
| Humidity | Operating Non-operating | 10% to 90% (non-condensing) 5% to 95% (non-condensing) | |
| Altitude | Operating Non-operating | 0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m) | |
| LED Activity | LED Amber – Radio OFF; LED White – Radio ON | | |

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

| in megrateu nouule with bluetooth 4.0/4.1/4.2/5.0 whetess retinology | | | |
|---|--|--|--|
| 4.0/4.1/4.2/5.0 Compliant | | | |
| 2402 to 2480 MHz | | | |
| Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH) | | | |
| Legacy: 3 Mbps signaling data rate ¹ 2.17 Mbps BLE: 1 Mbps signaling data rate ¹ 0.2 Mbps 1. Actual throughput may vary. Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels | | | |
| Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) | | | |
| The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR. | | | |
| Peak (Tx) 330 mW Peak (Rx) 230 mW | | | |
| | | | |





| | Selective Suspend 17 mW | | |
|--|--|--|--|
| Electrical Interface | USB 2.0 compliant | | |
| Bluetooth Software Supported Link Topology | Microsoft Windows Bluetooth Software | | |
| Power Management | Microsoft Windows ACPI, and USB Bus Support | | |
| Certifications | FCC (47 CFR) Part 15C, Section 15.247 & 15.249 | | |
| Power Management Certifications | ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark | | |
| Bluetooth Profiles Supported | BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) | | |
| Security & Manageability | Intel $^{\ensuremath{	iny one}}$ vPro $^{\ensuremath{	iny one}}$ support with appropriate Intel $^{\ensuremath{	iny one}}$ chipset components | | |



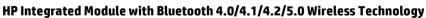
| Intel® 9560 802.11a/b/g/n/ac (2x2) Wi-Fi® and Bluetooth® 5.0 Combo¹ non-vPro | Wireless LAN Standards Interoperability Frequency Band | IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac Wi-Fi® certified 802.11b/g/n •2.402 – 2.482 GHz |
|---|--|--|
| | | 802.11a/n •4.9 – 4.95 GHz (Japan) •5.15 – 5.25 GHz •5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz |
| | Data Rates | •802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) •802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, , 80MHz & 160MHz) |
| | Modulation | Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM |
| | Security ³ | IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.11i Cisco Certified Extensions, all versions through CCX4 and CCX Lite WAPI |
| | Network Architecture Models | Ad-hoc (Peer to Peer) Infrastructure (Access Point Required) |
| | Roaming Output Power ² | IEEE 802.11 compliant roaming between access points •802.11b: +18.5dBm minimum •802.11g: +17.5dBm minimum •802.11a: +18.5dBm minimum •802.11n HT20(2.4GHz): +15.5dBm minimum •802.11n HT40(2.4GHz): +14.5dBm minimum •802.11n HT20(5GHz): +15.5dBm minimum •802.11n HT40(5GHz): +14.5dBm minimum •802.11ac VHT80(5GHz): +11.5dBm minimum •802.11ac VHT160(5GHz): +11.5dBm minimum |
| | Power Consumption | Transmit mode 2.0 W Receive mode 1.6 W Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated) Connected Standby 10mW Radio disabled 8 mW |



| Power Management | | press compliant power management nt power saving mode | |
|-----------------------------------|--|---|--|
| Receiver Sensitivity ³ | 802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum | | |
| Antenna type | High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications | | |
| Form Factor | PCI-Express M.2 MiniCard | | |
| Dimensions | Type 2230: 2.3 x 22.0 x 30.0 mm | | |
| Weight | Туре 2230: 2.8g | | |
| Operating Voltage | 3.3v +/- 9% | | |
| Temperature | Operating Non-operating | 14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C) | |
| Humidity | Operating Non-operating | 10% to 90% (non-condensing) 5% to 95% (non-condensing) | |
| Altitude | Operating Non-operating | 0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m) | |
| LED Activity | LED Amber – Ra | dio OFF; LED White – Radio ON | |

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

| HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology | | | |
|---|---|--|--|
| Bluetooth Specification | 4.0/4.1/4.2/5.0 Compliant | | |
| Frequency Band | 2402 to 2480 MHz | | |
| Number of Available Channels | Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH) | | |
| Signaling Data Rate | Legacy: 3 Mbps signaling data rate ¹ 2.17 Mbps BLE: 1 Mbps signaling data rate ¹ 0.2 Mbps 1. Actual throughput may vary. Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels | | |
| | Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) | | |
| Transmit Power | The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR. | | |
| Power Consumption | Peak (Tx) 330 mW Peak (Rx) 230 mW | | |





| | Selective Suspend 17 mW |
|---|--|
| Bluetooth Software Supported Link Topology | Microsoft Windows Bluetooth Software |
| Power Management | Microsoft Windows ACPI, and USB Bus Support |
| Certifications | FCC (47 CFR) Part 15C, Section 15.247 & 15.249 |
| Power Management Certifications | ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark |
| Bluetooth Software Supported | BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) |



| Intel® 22260 802.11a/b/g/n/ac/ax (2x2) Wi-Fi® 6 and Bluetooth® 5.1 Combo ¹ vPro | Wireless LAN Standards | IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11ac IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11h IEEE 802.11k IEEE 802.11k IEEE 802.11v |
|--|--------------------------------|---|
| | Interoperability | Wi-Fi [®] certified |
| | Frequency Band | 802.11b/g/n •2.402 – 2.482 GHz |
| | | 802.11a/n •4.9 – 4.95 GHz (Japan) •5.15 – 5.25 GHz •5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz |
| | Data Rates | •802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) •802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz & 160MHz) |
| | Modulation | Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM |
| | Security ³ | IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.11i Cisco Certified Extensions, all versions through CCX4 and CCX Lite WAPI |
| | Network Architecture Models | Ad-hoc (Peer to Peer) Infrastructure (Access Point Required) |
| | Roaming | IEEE 802.11 compliant roaming between access points |
| | Output Power ² | •802.11b: +18.5dBm minimum •802.11g: +17.5dBm minimum •802.11a: +18.5dBm minimum •802.11n HT20(2.4GHz): +15.5dBm minimum •802.11n HT40(2.4GHz): +14.5dBm minimum •802.11n HT20(5GHz): +15.5dBm minimum •802.11n HT40(5GHz): +14.5dBm minimum •802.11ac VHT80(5GHz): +11.5dBm minimum |



Technical Specifications

| | | 60(5GHz): +11.5dBm minimum (2.4GHz): +10dBm minimum | |
|-----------------------------------|--|--|--|
| | | 60(5GHz): +10dBm minimum | |
| Power Consumption | •Transmit mode 2.0 W •Receive mode 1.6 W •Idle mode (PSP) 180 mW (WLAN Associated) •Idle mode 50 mW (WLAN unassociated) •Connected Standby 10mW •Radio disabled 8 mW | | |
| Power Management | | ress compliant power management It power saving mode | |
| Receiver Sensitivity ³ | •802.11b, 1Mbps: -93.5dBm maximum •802.11b, 11Mbps: -84dBm maximum •802.11a/g, 6Mbps: -86dBm maximum •802.11a/g, 54Mbps: -72dBm maximum •802.11n, MCS07: -67dBm maximum •802.11n, MCS15: -64dBm maximum •802.11ac, MCS0: -84dBm maximum •802.11ac, MCS9: -59dBm maximum •802.11ax, MCS11(HT40): -59dBm maximum •802.11ax, MCS11(VHT160): -58.5dBm maximum | | |
| Antenna type | enclosure Two embedded o | ntenna with spatial diversity, mounted in the display dual band 2.4/5 GHz antennas are provided to the card to IMO communications and Bluetooth communications | |
| Form Factor | PCI-Express M.2 MiniCard | | |
| Dimensions | 1. Type 2230: 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm | | |
| Weight | 1. Type 2230: 2.8g 2. Type 126: 1.3g | | |
| Operating Voltage | 3.3v +/- 9% | | |
| Temperature | Operating Non-operating | 14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C) | |
| Humidity | Operating Non-operating | 10% to 90% (non-condensing) 5% to 95% (non-condensing) | |
| Altitude | Operating Non-operating | 0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m) | |

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

| HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology | | | |
|---|-------------------------------|--|--|
| Bluetooth Specification | 4.0/4.1/4.2/5.0/5.1 Compliant | | |
| Frequency Band | 2402 to 2480 MHz | | |
| Number of Available | Legacy: 0~79 (1 MHz/CH) | | |
| Channels | BLE: 0~39 (2 MHz/CH) | | |



| Signaling Data Rate | Legacy: 3 Mbps signaling data rate ¹ 2.17 Mbps BLE: 1 Mbps signaling data rate ¹ 0.2 Mbps 1. Actual throughput may vary. | | |
|---|--|--|--|
| | Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) | | |
| Transmit Power | The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR. | | |
| Power Consumption | Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW | | |
| Bluetooth Software Supported Link Topology | Microsoft Windows Bluetooth Software | | |
| Power Management | Microsoft Windows ACPI, and USB Bus Support | | |
| Certifications | FCC (47 CFR) Part 15C, Section 15.247 & 15.249 | | |
| Power Management Certifications | ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark | | |
| Bluetooth Software Supported | BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) | | |
| Security & Manageability | Intel $^{\circ}$ vPro ^{M} support with appropriate Intel $^{\circ}$ chipset components | | |



| Intel® 22260 802.11a/b/g/n/ac/ax (2x2) Wi-Fi® 6 and Bluetooth® 5.1 Combo ¹ non-vPro | Wireless LAN Standards | IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11ac IEEE 802.11ac IEEE 802.11d IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v Wi-Fi® certified |
|--|--------------------------------|---|
| | • • | |
| | Frequency Band | 802.11b/g/n/ax •2.402 – 2.482 GHz 802.11a/n/ac/ax •4.9 – 4.95 GHz (Japan) •5.15 – 5.25 GHz •5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz |
| | Data Rates | •802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: MCS 0 ~ MCS 15, (20MHz, and 40MHz) •802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz) • 802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz) |
| | Modulation | Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM |
| | Security ³ | IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.11i Cisco Certified Extensions, all versions through CCX4 and CCX Lite WAPI |
| | Network Architecture Models | Ad-hoc (Peer to Peer) Infrastructure (Access Point Required) |
| | Roaming | IEEE 802.11 compliant roaming between access points |
| | Output Power ² | •802.11b: +18.5dBm minimum •802.11g: +17.5dBm minimum •802.11a: +18.5dBm minimum •802.11n HT20(2.4GHz): +15.5dBm minimum •802.11n HT40(2.4GHz): +14.5dBm minimum •802.11n HT20(5GHz): +15.5dBm minimum •802.11n HT40(5GHz): +14.5dBm minimum |



| | •802.11ac VHT1 •802.11ax HT40 | 0(5GHz): +11.5dBm minimum 60(5GHz): +11.5dBm minimum (2.4GHz): +10dBm minimum 60(5GHz): +10dBm minimum | |
|-----------------------------------|---|---|--|
| Power Consumption | - | .6 W) 180 mW (WLAN Associated) W (WLAN unassociated) Idby 10mW | |
| Power Management | ACPI and PCI Express compliant power management 802.11 compliant power saving mode | | |
| Receiver Sensitivity ³ | •802.11b, 11Mb •802.11a/g, 6M •802.11a/g, 54 •802.11n, MCSC •802.11n, MCS1 •802.11ac, MCS •802.11ac, MCS •802.11ac, MCS | s: -93.5dBm maximum ps: -84dBm maximum bps: -86dBm maximum 4bps: -72dBm maximum 17: -67dBm maximum 5: -64dBm maximum 0: -84dBm maximum 9: -59dBm maximum 11 (HT40): -59dBm maximum 11 (VHT160): -58.5dBm maximum | |
| Antenna type | High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications | | |
| Form Factor | PCI-Express M.2 MiniCard | | |
| Dimensions | 1. Type 2230: 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm | | |
| Weight | 1. Type 2230: 2.8g 2. Type 126: 1.3g | | |
| Operating Voltage | 3.3v +/- 9% | | |
| Temperature | Operating Non-operating | 14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C) | |
| Humidity | Operating Non-operating | 10% to 90% (non-condensing) 5% to 95% (non-condensing) | |
| Altitude | Operating Non-operating | 0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m) | |

- 1. Check latest software/driver release for updates on supported security features.
- 2. Maximum output power may vary by country according to local regulations.
- 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

| HP Integrated Module with | n Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology |
|---------------------------|---|
| | |

| Bluetooth Specification | 4.0/4.1/4.2/5.0/5.1 Compliant |
|-------------------------|-------------------------------|
| Frequency Band | 2402 to 2480 MHz |
| Number of Available | Legacy: 0~79 (1 MHz/CH) |
| Channels | BLE: 0~39 (2 MHz/CH) |



| Signaling Data Rate | Legacy: 3 Mbps signaling data rate ¹ to 2.17 Mbps BLE: 1 Mbps signaling data rate ¹ 0.2 Mbps 1. Actual throughput may vary. | |
|---|--|--|
| | Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels | |
| | Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) | |
| Transmit Power | The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR. | |
| Power Consumption | Peak (Tx) 330 mW Peak (Rx) 230 mW Selective Suspend 17 mW | |
| Bluetooth Software Supported Link Topology | Microsoft Windows Bluetooth Software | |
| Power Management | Microsoft Windows ACPI, and USB Bus Support | |
| Certifications | FCC (47 CFR) Part 15C, Section 15.247 & 15.249 | |
| Power Management Certifications | ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark | |
| Bluetooth Software Supported | BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) | |



Technical Specifications

| Intel®XMM 7360 LTE- Advanced CAT9 | Technology/Operating bands | FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 1400 (Band 11), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1400 (Band 21), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 1700/2100 (Band 66). TDD LTE: 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41). HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz |
|--------------------------------------|---|--|
| | Wireless protocol standards | 3GPP Release 11 LTE Specification CAT.9, DL 60MHz BW throughput up to 450Mbps; UL 20MHz throughput up to 50Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification |
| | GPS | Standalone, A-GPS (MS-A, MS-B) |
| | GPS bands | 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz |
| | Maximum data rates | LTE: 450 Mbps (Download), 50 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload) |
| | Maximum output power | LTE: 23 dBm HSPA+: 23.5 dBm |
| | Maximum power consumption | LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average) |
| | Form Factor | M.2, 3042-S3 Key B |
| | Weight | 5.8 g |
| | Dimensions (Length x Width x Thickness) | 42 x 30 x 2.3 mm |
| | | ional feature. Connection requires wireless data service contract, network |

support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

| Intel ® XMM 7262 LTE- Advanced CAT6 | Technology/Operating bands | FDD LTE: 2100 (Band 1), 1800 (Band 3), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 800 (Band 20), 700 (Band 28), HSPA+: 2100 (Band 1), 850 (Band 5), 900 (Band 8) |
|--|--------------------------------|--|
| | Wireless protocol standards | 3GPP Release 11 LTE Specification CAT.6, DL 40MHz BW throughput up to 300Mbps; UL 20MHz throughput up to 50Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification |
| | GPS | Standalone, A-GPS (MS-A, MS-B and XTRA) |
| | GPS bands | 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz |
| | Maximum data rates | LTE: 300 Mbps (Download), 50 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) UMT: 384 kbps (Download), 384 kbps (Upload) |
| | Maximum output power | LTE: 23 dBm HSPA+: 23.5 dBm |



Technical Specifications

| Maximum power consumption | LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average) |
|---|--|
| Form Factor | M.2, 3042-S3 Key B |
| Weight | 6 g |
| Dimensions (Length x Width x Thickness) | 42 x 30 x 2.3 mm |
| | optional feature. Connection requires wireless data service co lable in all areas. Contact service provider to determine the co |

Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

| Intel® XMM™ 7560 LTE- Advanced Pro | Technology/Operating bands | FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 1700/2100 (Band 66). TDD LTE: 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 5200 (Band 46 RX only) HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MH |
|---------------------------------------|---|---|
| | Wireless protocol standards | 3GPP Release 12 LTE Specification DL-CAT.16, DL 100MHz BW throughput up to 978Mbps; UL-CAT.13 40MHz throughput up to 150Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification |
| | GPS | Standalone, A-GPS (MS-B and LTO) |
| | GPS bands | GPS 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 ± 2.046 MHz |
| | Maximum data rates | LTE: 978 Mbps (Download), 150 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload) |
| | Maximum output power | LTE: 23 dBm in all bands except B41 LTE B41 HPUE: 26dBm HSPA+: 23.5 dBm |
| | Maximum power consumption | LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average) |
| | Form Factor | M.2, 3042-S3 Key B |
| | Weight | 6 g |
| | Dimensions (Length x Width x Thickness) | 42 x 30 x 2.3 mm |

Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and



Technical Specifications

availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

| Near Field Communications Controller (optional) | Dimensions (L x W x H) Chipset System interface NFC RF standards | Module 17 mm by 10 mm by 2.0 mm NPC300 I2C ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092 |
|--|---|---|
| | NFC Forum Support Reader (PCD-VCD) | ECMA-340 NFCIP-1 Target and Initiator ECMA-320 NFCIP-2 Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2 ISO/IEC 14443 A |
| | Mode (1) | ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire FeliCa Jewel and Topaz cards |
| | Card Emulation (PICC- VICC) Mode (1) | ISO/IEC 14443 A ISO/IEC 14443 B and B' MIFARE FeliCa |
| | Frequency | 13.56 MHz |
| | NFC Modes Supported | Reader/Writer, Peer-to-Peer |
| | Raw RF Data Rates | 106, 212, 424, 848 kbps |
| | Operating temperature | -25 C to 80°C |
| | Storage temperature | -20°C to 125°C |
| | Humidity | 10-90% operating 5-95% non-operating |
| | Supply Operating voltage | 2.7 to 5.5 Volts |
| | I/O Voltage | 1.8V or 3.3V |
| Power Consumption (Booster enable, VBAT= 3.3V, VCC_BOOST = 5V) | Mode | Power Consumption, Typical |
| | Polling | 710.93 mW |
| | Detected Test Tag Type 1 | |
| | Detected Test Tag Type 2 | |
| | Detected Test Tag Type 3 | 383.76 mW |
| | Detected Test Tag Type 4 | |
| | Antenna | Antenna connector, 0.3mm pitch, 7 connector FPC. Antenna matching is external to module. |



Technical Specifications

| Intel® i219LM | Connector | RJ-45 |
|-------------------------------|-----------------------------|---|
| 10/100/1000 Integrated NIC | System Interface | PCI(Intel proprietary) + SMBus |
| | Data rates supported | 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s |
| | IEEE Compliance | IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE (Energy Efficient Ethernet) |
| | Performance | TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K |
| | Power consumption | Cable Disconnection: 25mW 100Mbps Full Run: 450mW 1000bp Full Run: 1000mW WoL Enable(S3/S4/S5): 50mW WoL Disable(S3/S4/S5): 25mW |
| | Power Management | ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption |
| | Management Interface | Auto MDI/MDIX Crossover cable detection |
| | IT Manageability | Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status |
| | Security & Manageability | Intel $^{\circ}$ vPro $^{\mathrm{TM}}$ support with appropriate Intel $^{\circ}$ chipset components |
| | Mobile Broadband is an opti | onal feature. Connection requires wireless data service contract, network |

Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.



Technical Specifications

| Intel® i219v | Connector | RJ-45 | |
|-------------------------------|--|---|--|
| 10/100/1000 Integrated NIC | System Interface | PCI(Intel proprietary) + SMBus | |
| | Data rates supported | 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s | |
| | IEEE Compliance | IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE (Energy Efficient Ethernet) | |
| | Performance | TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K | |
| | Power consumption | Cable Disconnection: 25mW 100Mbps Full Run: 450mW 1000bp Full Run: 1000mW WoL Enable(S3/S4/S5): 50mW WoL Disable(S3/S4/S5): 25mW | |
| | Power Management | ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption | |
| | Management Interface | Auto MDI/MDIX Crossover cable detection | |
| | IT Manageability | Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status | |
| | Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and | | |

support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.



Technical Specifications

POWER

| AC Adapter 45 Watt nPFC Wall Mount USB type C Straight 1.8m C6NS | Dimensions (H x W x D) | 62.0 x 62.0 x 28.5mm | |
|--|----------------------------------|---|---|
| | Weight | unit: 220g +/- 10g | |
| | Input | Input Efficiency | Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec: 5V: 81.5% 9V: 86.7% 10V: 87.5% 12V: 87.8% 15V: 87.8% 20V: 87.8% |
| | | Input frequency range | 47 ~ 63Hz |
| | | Input AC current | Max. 1.4 A at 90 Vac |
| | Output | Output power | Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec: |
| Connector | | DC output | 5V: 81.5% |
| | | Hold-up time | 9V: 86.7% |
| | | Output current limit | 10V: 87.5% |
| | Connector | Non-Standard C6 | |
| | Environmental Design | Operating temperature | 32oF to 95oF (0oto 35oC) |
| | | Non-operating (storage) | |
| | | temperature | -4oF to 185oF (-20oto 85oC) |
| | | Altitude | 0 to 16,400 ft (0 to 5000m) |
| | | Humidity | 20% to 95% |
| | | Storage Humidity | 10% to 95% |
| | EMI and Safety Certifications | * Worldwide safety standa SELV; Agency approvals – FCC Class B, CISPR22 Class | with LVD and EMC directives ards - IEC60950, EN60950, UL60950, Class1, C-UL-US, NORDICS, DENAN, EN55022 Class B, B, CCC, NOM-1 NYCE. urs at 25°C ambient condition. |



| AC Adapter 45 Watt Smart nPFC Standard Barrel | Dimensions (H x W x D) Weight | 95.0x40.0x26.5mm unit: 200g +/- 10g | |
|--|----------------------------------|---|---|
| 4.5 mm Right Angle 1.8 m | Input | Input Efficiency | 87.74 % at 115 Vac and 88.4 % at 230Vac |
| | • • • | Input frequency range | 47 ~ 63 Hz |
| | | Input AC current | Max. 1.4 A at 90 Vac |
| | Output | Output power | 45W |
| | | DC output | 19.5V |
| | | Hold-up time | 5ms at 115 Vac input |
| | | Output current limit | <8.0A |
| | Connector | C6 | |
| | Environmental Design | Operating temperature | 32° to 95°F (0° to 35°C) |
| | | Non-operating (storage) temperature | -4° to 185°F (-20° to 85°C) |
| | | Altitude | 0 to 16,400 ft (0 to 5000m) |
| | | Humidity | 20% to 95% |
| | | Storage Humidity | 10% to 95% |
| | EMI and Safety Certifications | * Worldwide safety standa SELV; Agency approvals – FCC Class B, CISPR22 Class | with LVD and EMC directives ords - IEC60950, EN60950, UL60950, Class1, C-UL-US, NORDICS, DENAN, EN55022 Class B, B, CCC, NOM-1 NYCE. ors at 25°C ambient condition. |

| AC Adapter 45 Watt Smart nPFC Standard Barrel 4.5 mm Right Angle 1.8 m | Dimensions (H x W x D) | 95.0 x 40.0 x 26.5mm | |
|--|------------------------|--|---|
| | Weight | unit: 200g +/- 10g | |
| 2prong | Input | Input Efficiency | 87.74 % at 115 Vac and 88.4 % at 230Vac |
| | | Input frequency range | 47 ~ 63 Hz |
| | | Input AC current | Max. 1.4 A at 90 Vac |
| | Output | Output power | 45W |
| | | DC output | 19.5V |
| | | Hold-up time | 5ms at 115 Vac input |
| | | Output current limit | <8.0A |
| | Connector | С8 | |
| | Environmental Design | Operating temperature | 32° to 95°F (0° to 35°C) |
| | | Non-operating (storage) temperature | -4° to 185°F (-20° to 85°C) |
| | | Altitude | 0 to 16,400 ft (0 to 5000m) |



| | | Humidity | 20% to 95% |
|---|----------------------------------|--|--|
| | | Storage Humidity | 10% to 95% |
| | EMI and Safety Certifications | *CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition. | |
| AC Adapter 65 Watt nPFC USB type C Straight 1.8m | Dimensions (H x W x D) | 74 x 74 x 28.5 mm | |
| C6NS | Weight | unit: 245g +/- 10g | |
| | Input | Input Efficiency | 81.5% min at 115 Vac/ 230Vac @ 5V/3A 86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 10V/5A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A |
| | | Input frequency range | 47 to 63 Hz |
| | | Input AC current | 1.7 A at 90 VAC and maximum load |
| | Output | Output power | 65W |
| | | DC output | 5V/9V/10V/12V/15V/20V |
| | | Hold-up time | 5ms at 115 Vac input |
| | | Output current limit | <8.0A |
| | Connector | Non-Standard C6 | |
| | Environmental Design | Operating temperature | 32°F to 95°F (0° to 35°C) |
| | | Non-operating (storage) temperature | -4°F to 185°F (-20° to 85°C) |
| | | Altitude | 0 to 16,400 ft (0 to 5000m) |
| | | Humidity | 5% to 95% |
| | | Storage Humidity | 5% to 95% |
| | EMI and Safety Certifications | *CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950, EN60950, UL60950, Cla SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Cl FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. * MTBF - over 100,000 hours at 25°C ambient condition. | |

| AC Adapter 65 Watt Smart | : Dimensions (H x W x D) | 102 x 55 x 30 mm | |
|--------------------------------|--------------------------|-----------------------|--|
| nPFC EM Barrel 4.5mm New EM | Weight | unit: 250g +/- 10g | |
| NEWLM | Input | Input Efficiency | 88.0 % at 115 Vac and 89.0 % at 230Vac |
| | | Input frequency range | 47 ~ 63 Hz |



| | Input AC current | Max. 1.7 A at 90 Vac |
|----------------------------------|--|------------------------------|
| Output | Output power | 65W |
| | DC output | 19.5V |
| | Hold-up time | 5ms at 115 Vac input |
| | Output current limit | <11.0A |
| Connector | C6 | |
| Environmental Design | Operating temperature | 32°F to 95°F (0° to 35°C) |
| | Non-operating (storage) temperature | -4°F to 185°F (-20° to 85°C) |
| | Altitude | 0 to 16,400 ft (0 to 5000m) |
| | Humidity | 20% to 95% |
| | Storage Humidity | 10% to 95% |
| EMI and Safety Certifications | *CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. * MTBF - over 100,000 hours at 25°C ambient condition. | |

| AC Adapter 65 Watt Smart nPFC Standard Barrel | | 90.0 x 51 x 28.5mm | |
|--|----------------------------------|--|--|
| 4.5mm Right Angle 1.8m | Weight | unit: 230g +/- 10g | |
| ······································ | Input | Input Efficiency | 88.0 % at 115 Vac and 89.0 % at 230Vac |
| | | Input frequency range | 47 ~ 63 Hz |
| | | Input AC current | Max. 1.7 A at 90 Vac |
| | Output | Output power | 65W |
| | | DC output | 19.5V |
| | | Hold-up time | 5ms at 115 Vac input |
| | | Output current limit | <11.0A |
| | Connector | Non-Standard C6 | |
| | Environmental Design | Operating temperature | 32°F to 95°F (0° to 35°C) |
| | | Non-operating (storage) temperature | 32°F to 95°F (0° to 35°C) |
| | | Altitude | 0 to 16,400 ft (0 to 5000m) |
| | | Humidity | 20% to 95% |
| | | Storage Humidity | 10% to 95% |
| | EMI and Safety Certifications | *CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. | |



Technical Specifications

* MTBF - over 100,000 hours at 25°C ambient condition.

| Battery SS 3 Cell 50 WHr Long Life -PL | Dimensions (H x W x D) Weight Cells/Type | L 278.7mm x W 76.3mm x H 7.1mm 193 +/- 10g 3cell Lithium-Ion Polymer cell / P604883A1 | |
|---|--|---|--------------------------|
| | Energy | Voltage | 11.55V |
| | | Amp-hour capacity | 4.113Ah/ 4.330Ah |
| | | Watt-hour capacity | 50Wh |
| | Temperature | Operating (Charging) | 0° to 50° C |
| | | Operating (Discharging) | -10° to 60° C |
| | | Warranty | based on system offering |
| | | Optional Travel Battery Available | No |



Technical Specifications

Country of Origin

China



Options and Accessories (Sold separately and availability may vary by country)

| Туре | Description | Part Number |
|--------------|---|-------------|
| Cases | HP Essential Top Load Case (up to 15.6") | H2W17AA#xxx |
| | HP Slim Ultrabook Top Load | F3W15AA#xxx |
| | HP Basic/Essential Backpack | H1D24AA#xxx |
| | HP Exec Midnight 15.6" Backpack | 1KM16AA#xxx |
| Docking | HP UltraSlim Docking Station | D9Y32AA#xxx |
| | HP UltraSlim Docking Station TAA US | E5C22AV#ABA |
| | HP Thunderbolt Dock 120W G2 | 2UK37AA |
| | HP Thunderbolt Dock 230W G2 | 2UK38AA |
| | HP TB Dock Audio Module | 3AQ21AA |
| | HP TB Dock 120W G2 cable | 3XB94AA |
| | HP TB Dock G2 combo cable | 3XB96AA |
| | HP USB-C Universal Dock | 1MK33AA#xxx |
| | HP Elite 90W Thunderbolt 3 Dock | 1DT93AA#xxx |
| | HP USB-C Dock G4 | 3FF69AA#xxx |
| | HP USB-C Mini Dock | 1PM64AA#xxx |
| | HP USB-C Travel Dock | T0K29AA#xxx |
| | HP USB Travel Dock | T0K30AA#xxx |
| | HP USB-C Universal Dock w/4.5mm Adapter | 2UF95AA |
| | HP USB-C Universal Dock w/4.5mm Adapter - non-flash version | 3DV65AA |
| | HP USB-C Dock G5 | 5TW10AA#XXX |
| | HP USB-C/A Universal Dock G2 | 5TW13AA#XXX |
| | HP Adjustable Dual Display Stand | AW664AA#xxx |
| | HP Display and Notebook Stand II | E8G00AA#xxx |
| | HP TB Dock G2 w/ Combo Cable | 3TR87AA |
| | HP TB Dock 120W G2 w/ Audio | 3YE87AA |
| Input/Output | HP Slim Wireless Keyboard and Mouse | T6L04AA#xxx |
| | HP Slim USB Keyboard and Mouse | T6T83AA#xxx |
| | HP Wireless (Link-5) Keyboard | T6U20AA#xxx |
| | HP USB Essential Keyboard and Mouse | H6L29AA#xxx |
| | HP Conferencing Keyboard | K8P74AA#xxx |
| | HP USB Collaboration Keyboard | Z9N38AA#xxx |
| | HP Wireless Collaboration Keyboard | Z9N39AA#xxx |
| | HP Comfort Grip Wireless Mouse | H2L63AA#xxx |
| | HP X4000b Bluetooth Mouse | H3T50AA#xxx |
| | HP 3-Button USB Laser Mouse | H4B81AA#xxx |
| | HP USB Travel Mouse | G1K28AA#xxx |
| | HP Ultra Mobile Wireless Mouse | H6F25AA#xxx |
| | HP Slim Bluetooth Mouse to AMO | F3J92AA#xxx |
| | HP Wireless Premium Mouse | 1JR31AA#xxx |
| | HP USB Premium Mouse | 1JR32AA#xxx |



Options and Accessories (Sold separately and availability may vary by country)

| | HP EliteDisplay E243 23.8-inch Monitor | 1FH47AA |
|----------|--|----------------------------|
| Displays | HP EliteDisplay E243d 23.8-inch Docking Monitor | 1TJ76AA |
| | | |
| | HP Dual Head Keyed Cable Lock | T1A64AA#xxx |
| | HP Keyed Cable Lock 10mm | T1A62AA#xxx |
| | HP Keyed Cable lock | TOYISAA#XXX TOYI4AA#XXX |
| | HP Essential Combination Lock | TOY15AA#XXX TOY15AA#XXX |
| Jecuilly | HP Docking Station Cable Lock HP Essential Combination Lock | Т0Ү16АА#ххх |
| Security | HP Docking Station Cable Lock | AU656AA#xxx |
| | HP 512GB M2 PCIe NVME SSD TLC 2280) | 1FU88AA#xxx |
| | HP 256GB M2 PCIe NVME SSD TLC (2280) | 1FU87AA#xxx |
| Storage | HP USB External DVDRW Drive | F2B56AA#xxx |
| | | |
| | HP UC Wireless Duo Headset | W3K09AA#xxx |
| | HP UC Wireless Mono Headset | W3K08AA#xxx |
| | HP Stereo USB Headset | T1A67AA#xxx |
| UCC | HP Stereo 3.5mm Headset | T1A66AA#xxx |
| | HP 65W USB-C Power Adapter | 1HE08AA#xxx |
| | HP 45W USB-C Power Adapter | 1HE07AA#xxx |
| | HP USB-C Notebook Power Bank | 1TZ86AA#xxx |
| | HP Notebook Power Bank | N9F71AA#xxx |
| | 65W USB-C Slim Power Adapter | 3PN48AA |
| | HP 65W USB-C Power Adapter | 1HE08AA#xxx |
| | HP 45W USB-C Power Adapter | 1HE07AA#xxx |
| | HP 45W 2-prong 4.5 mm DC jack AC Adapter | L6F60AA#ABJ |
| | HP 90W Smart AC Adapter | H6Y90AA#xxx |
| | HP 65W Smart AC Adapter | H6Y89AA#xxx |
| | HP 45W Smart AC Adapter | H6Y88AA#xxx |
| | HP 90W Slim Combo AC Adapter w/ USB | H6Y84AA#xxx |
| | HP 90W Slim AC Adapter | Н6Ү8ЗАА#ххх |
| Power | HP 65W Slim AC Adapter | H6Y82AA#xxx |
| | HP USB-C to HDMI 2.0 Adapter | 1WC36AA#xxx |
| | HP HDMI to VGA | H4F02AA#xxx |
| | HP HDMI to DVI | F5A28AA#xxx |
| | HP USB-C to VGA | N9K76AA#xxx |
| | HP USB-C to DP | N9K78AA#xxx |
| | HP USB-C to USB-A Hub | Z6A00AA#xxx |
| | HP USB-C to USB 3.0 Adapter | N2Z63AAA#xxx |
| | HP Elite Presenter Mouse | 2CE30AA#xxx |
| | HP Essential USB Mouse | 2TX37AA#xxx |



Options and Accessories (Sold separately and availability may vary by country)

HP EliteDisplay E273q 27-inch Monitor

1FH52AA



Change Log

| Date of change: | Version History: | | Description of change: |
|-----------------|------------------|---------|------------------------|
| May 28, 2019 | From V1 to V2 | Updated | Sure View Gen3 |
| May 30, 2019 | From V2 to V3 | Updated | Lock Slot |

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